

**Description**

AH276 are integrated Hall sensors with output drivers, mainly designed for electronic commutation of brush-less DC Fan. This IC internally includes the regulator, protecting diode, Hall plate, amplifier, comparator, and a pair of complementary open-collector outputs (**DO**, **DOB**).

While the magnetic flux density (**B**) is larger than operate point (**Bop**), **DO** will turn on (low), and meanwhile **DOB** will turn off (high). Each output is latched until **B** is lower than release point (**Brp**), and then **DO**, **DOB** transfer each state.

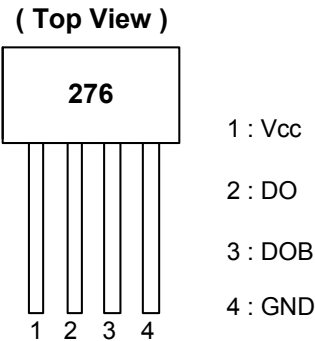
For DC fan application, sometimes need to test power reverse connection condition. Internal diode only protects chip-side but not for coil-side. If necessary, add one external diode to block the reverse current from coil-side.

**Features**

- On-chip Hall sensor with two different sensitivity and hysteresis settings for AH276
- Built-in protecting diode only for chip reverse power connecting
- -20°C to +85°C operating temperature
- Lead Free Package: SIP-4L
- SIP-4L: Available in "Green" Molding Compound (No Br, Sb)
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

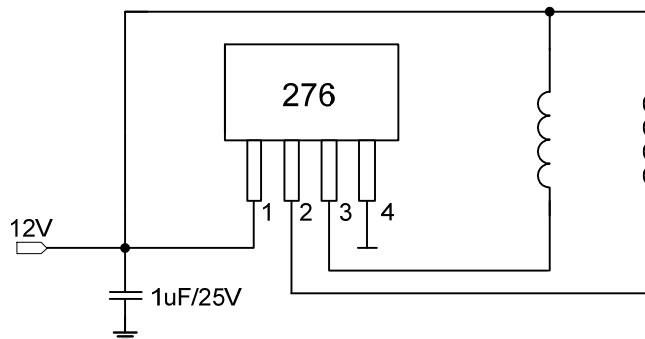
**Pin Assignments**



**Applications**

- Dual-coil Brush-less DC Motor
- Dual-coil Brush-less DC Fan
- Revolution Counting
- Speed Measurement

**Typical Applications Circuit**

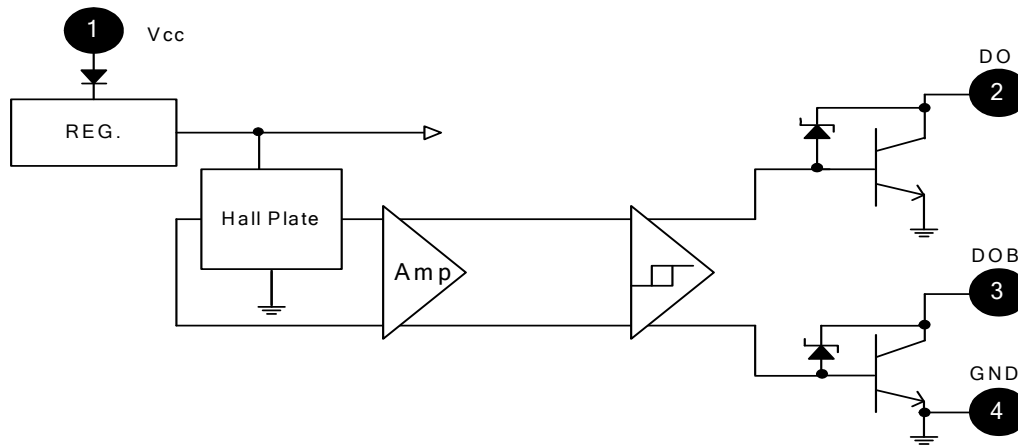


**Brush-less DC Fan**

**Pin Descriptions**

| Pin Name        | P/I/O | Pin # | Function           |
|-----------------|-------|-------|--------------------|
| V <sub>CC</sub> | P     | 1     | Power Supply Input |
| DO              | O     | 2     | Output Pin         |
| DOB             | O     | 3     | Output Pin         |
| GND             | P     | 4     | Ground             |

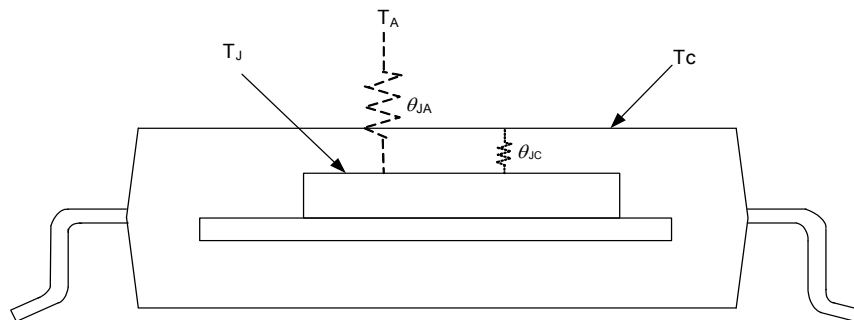
**Functional Block Diagram**



**Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Symbol           | Parameter                                       | Rating          | Unit |
|------------------|---|-----------------|------|
| V <sub>CC</sub>  | Supply Voltage                                  | 20              | V    |
| V <sub>RCC</sub> | Reverse VCC Polarity Voltage                    | -20             | V    |
| B                | Magnetic Flux Density                           | Unlimited       |      |
| I <sub>O</sub>   | Output "on" Current (Note 3)                    | Continuous      | 0.4  |
|                  |   | Hold            | 0.5  |
|                  |   | Peak (Start Up) | 0.7  |
| T <sub>S</sub>   | Storage Temperature Range                       | -65 ~ +150      | °C   |
| PD               | Package Power Dissipation (SIP-4L)              | 550             | mW   |
| T <sub>J</sub>   | Maximum Junction Temperature                    | +150            | °C   |
| θ <sub>JA</sub>  | Thermal Resistance Junction-to-Ambient (SIP-4L) | 227             | °C/W |
| θ <sub>JC</sub>  | Thermal Resistance Junction-to-Case (SIP-4L)    | 49              | °C/W |

Note: 3. P<sub>O</sub> shall be within Safety Operation Area.



**Recommended Operating Conditions** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

| Symbol   | Parameter                     | Conditions | Min | Max | Unit             |
|----------|-------------------------------|------------|-----|-----|------------------|
| $V_{CC}$ | Supply Voltage (Note 4)       | Operating  | 3.5 | 20  | V                |
| $T_A$    | Operating Ambient Temperature | Operating  | -20 | +85 | $^\circ\text{C}$ |

Note: 4. The output DO/DOB is switching as magnetic field change ( $S > 300\text{G}$ ,  $N < -300\text{G}$ ).

**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

| Symbol        | Parameter                 | Conditions                                    | Min | Typ  | Max | Unit          |
|---------------|---------------------------|---|-----|------|-----|---------------|
| $V_Z$         | Output Zener Breakdown    |   | —   | 35   | —   | V             |
| $V_{CE(SAT)}$ | Output Saturation Voltage | $V_{CC} = 14\text{V}$ , $I_L = 400\text{mA}$  | —   | 0.6  | 0.9 | V             |
| $I_{CEX}$     | Output Leakage Current    | $V_{CE} = 14\text{V}$ , $V_{CC} = 14\text{V}$ | —   | <0.1 | 10  | $\mu\text{A}$ |
| $I_{CC}$      | Supply Current            | $V_{CC} = 20\text{V}$ , Output Open           | 7   | 16   | 25  | mA            |

**Magnetic Characteristics** (Note 5) (@ $T_A = +25^\circ\text{C}$ ,  $V_{CC} = 14\text{V}$ , unless otherwise specified.)

**A grade**

| Symbol | Characteristic | Min | Typ | Max | Unit  |
|--------|----------------|-----|-----|-----|-------|
| Bop    | Operate Point  | 10  | —   | 50  | Gauss |
| Brp    | Release Point  | -50 | —   | -10 | Gauss |
| Bhy    | Hysteresis     | —   | 75  | —   | Gauss |

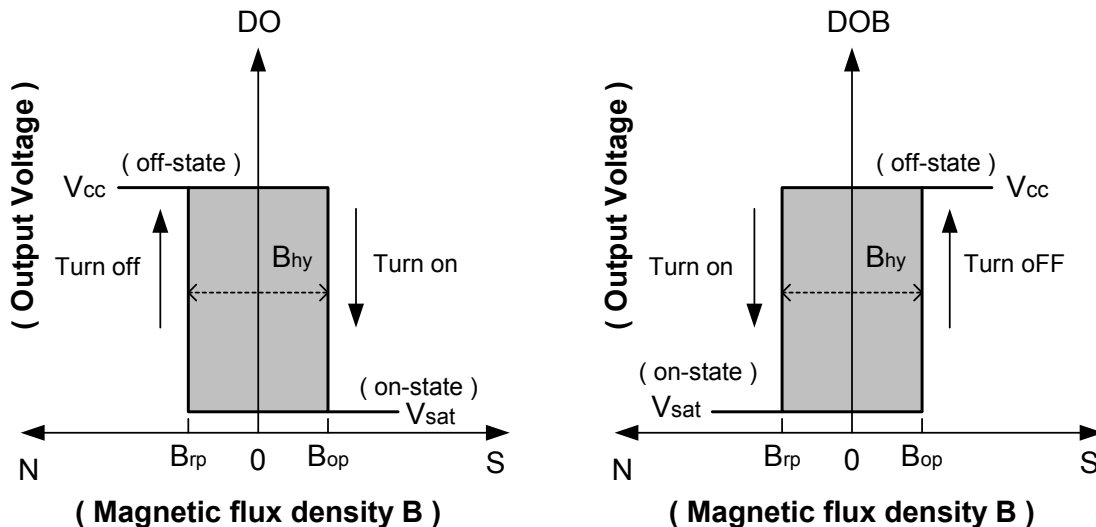
**B grade**

| Symbol | Characteristic | Min | Typ | Max | Unit  |
|--------|----------------|-----|-----|-----|-------|
| Bop    | Operate Point  | 5   | —   | 70  | Gauss |
| Brp    | Release Point  | -70 | —   | -5  | Gauss |
| Bhy    | Hysteresis     | —   | 75  | —   | Gauss |

**C grade**

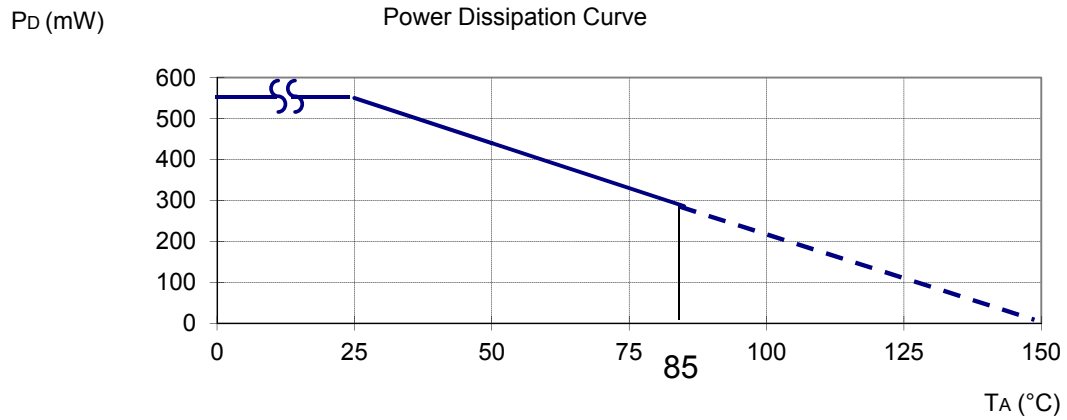
| Symbol | Characteristic | Min  | Typ | Max | Unit  |
|--------|----------------|------|-----|-----|-------|
| Bop    | Operate Point  | —    | —   | 100 | Gauss |
| Brp    | Release Point  | -100 | —   | —   | Gauss |
| Bhy    | Hysteresis     | —    | 75  | —   | Gauss |

Note: 5. Magnetic characteristics are for design information, which will vary with supply voltage, operating temperature and after soldering.

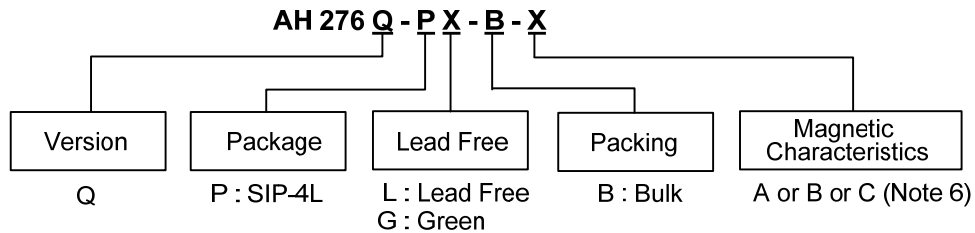


**Performance Characteristics**

|                           |     |     |     |     |     |     |     |     |     |
|---------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| <b>T<sub>A</sub> (°C)</b> | 25  | 50  | 60  | 70  | 80  | 85  | 90  | 95  | 100 |
| <b>P<sub>D</sub> (mW)</b> | 550 | 440 | 396 | 352 | 308 | 286 | 264 | 242 | 220 |
| <b>T<sub>A</sub> (°C)</b> | 105 | 110 | 115 | 120 | 125 | 130 | 135 | 140 | 150 |
| <b>P<sub>D</sub> (mW)</b> | 198 | 176 | 154 | 132 | 110 | 88  | 66  | 44  | 0   |



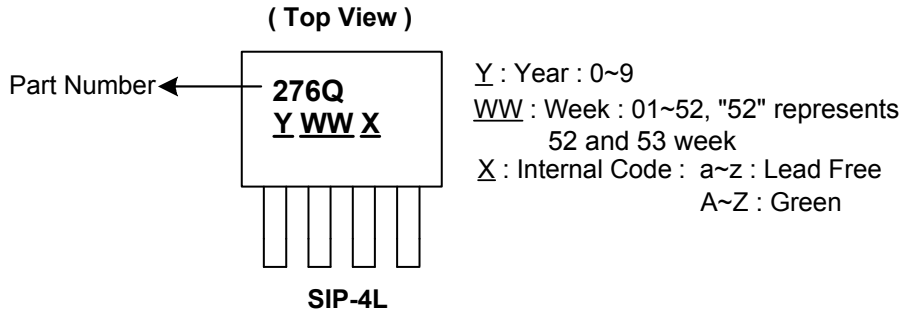
**Ordering Information**



| Part Number   | Package Code | Packaging | Bulk     |                    | Magnetic Characteristics |
|---------------|--------------|-----------|----------|--------------------|--------------------------|
|               |              |           | Quantity | Part Number Suffix |                          |
| AH276Q-PL-B-A | P            | SIP-4L    | 1000     | -B                 | A                        |
| AH276Q-PL-B-B | P            | SIP-4L    | 1000     | -B                 | B                        |
| AH276Q-PL-B-C | P            | SIP-4L    | 1000     | -B                 | C                        |
| AH276Q-PG-B-A | P            | SIP-4L    | 1000     | -B                 | A                        |
| AH276Q-PG-B-B | P            | SIP-4L    | 1000     | -B                 | B                        |
| AH276Q-PG-B-C | P            | SIP-4L    | 1000     | -B                 | C                        |

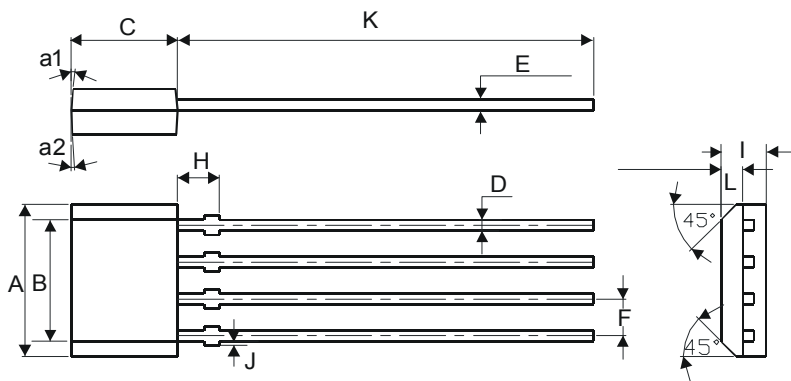
Note: 6. Please refer to page 3 (Magnetic Characteristics table).

**Marking Information**

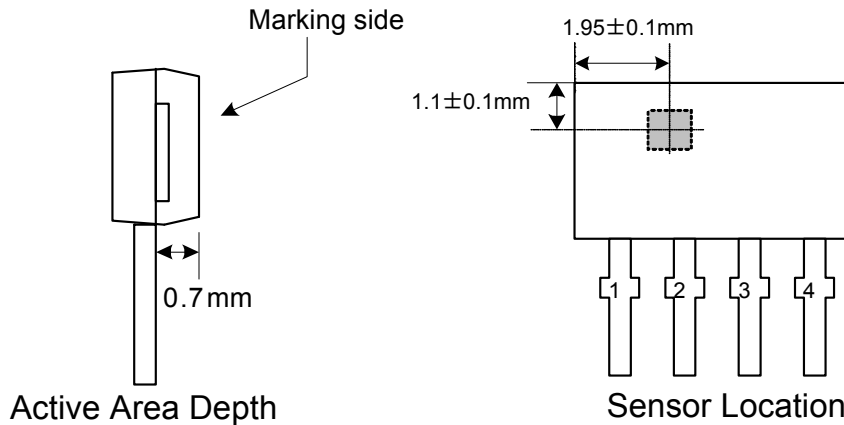


**Package Outline Dimensions** (All dimensions in mm.)

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



| SIP-4                |       |      |
|----------------------|-------|------|
| Dim                  | Min   | Max  |
| A                    | 5.12  | 5.32 |
| B                    | 4.10  | 4.30 |
| C                    | 3.55  | 3.75 |
| D                    | 0.38  | 0.44 |
| E                    | 0.35  | 0.41 |
| F                    | 1.24  | 1.30 |
| H                    | 1.32  | 1.52 |
| I                    | 1.45  | 1.65 |
| J                    | 0.00  | 0.2  |
| K                    | 13.00 | 15.5 |
| L                    | 0.63  | 0.83 |
| a1                   | 3°    | 5°   |
| a2                   | 4°    | 7°   |
| All Dimensions in mm |       |      |



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